LM158QML Low Power Dual Operational Amplifiers

Check for Samples: LM158QML

FEATURES

- **Available with Radiation Specification**
  - **High Dose Rate 100 krad(Si)**
  - **ELDRS Free 100 krad(Si)**
- **Internally Frequency Compensated for Unity Gain**
- **Large DC Voltage Gain: 100 dB**
- **Wide Bandwidth (Unity Gain): 1 MH z(Temperature Compensated)**
- **Wide Power Supply Range:**
  - **Single Supply: 3V to 32V**
  - **Or Dual Supplies: ±1.5V to ±16V**
- **Very Low Supply Current Drain (500 µA) − Essentially Independent of Supply Voltage**
- **Low Input Offset Voltage: 2 mV**
- **Input Common-mode Voltage Range Includes Ground**
- **Differential Input Voltage Range Equal to the Power Supply Voltage**
- **Large Output Voltage Swing: 0V to V^+ − 1.5V**

UNIQUE CHARACTERISTICS

- In the Linear Mode the Input Common-Mode Voltage Range Includes Ground and the Output Voltage can also Swing to Ground, even though Operated from only a Single Power Supply Voltage.
- The Unity Gain Cross Frequency is Temperature Compensated.
- The Input Bias Current is also Temperature Compensated.

ADVANTAGES

- Two Internally Compensated Op Amps
- Eliminates Need for Dual Supplies
- Allows Direct Sensing Near Gnd and V_O also Goes to Gnd
- Compatible with all Forms of Logic
- Power Drain Suitable for Battery Operation

DESCRIPTION

The LM158 series consists of two independent, high gain, internally frequency compensated operational amplifiers which were designed specifically to operate from a single power supply over a wide range of voltages. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage.

Application areas include transducer amplifiers, dc gain blocks and all the conventional op amp circuits which now can be more easily implemented in single power supply systems. For example, the LM158 series can be directly operated off of the standard +5V power supply voltage which is used in digital systems and will easily provide the required interface electronics without requiring the additional ±15V power supplies.

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Connection Diagrams

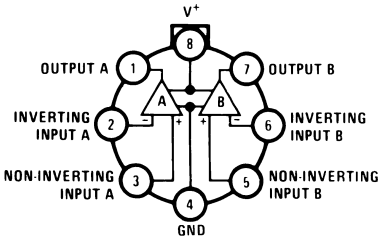


Figure 1. TO-99 Package
See Package Number LMC0008C

Top View

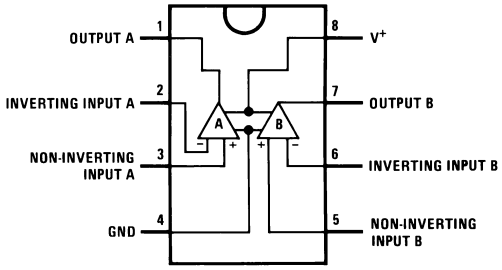


Figure 2. CDIP Package
See Package Number NAB0008A

Top View

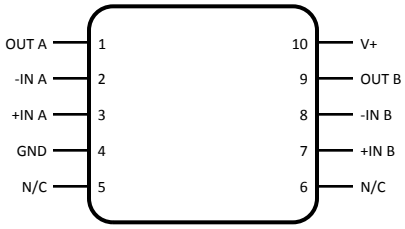
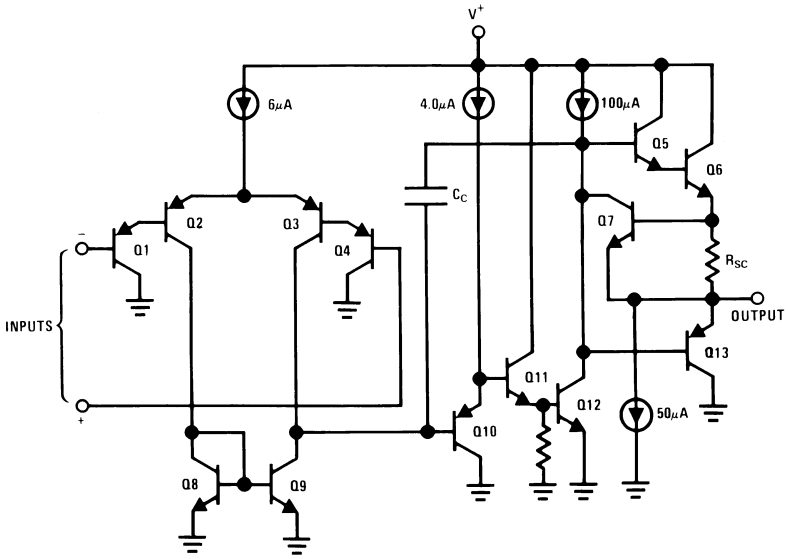


Figure 3. 10 Lead CLGA Package
See Package Number NAC0010A

Schematic Diagram

(Each Amplifier)



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings(1)

Supply Voltage, V^+			$32V_{DC}$
Differential Input Voltage			$32V_{DC}$
Input Voltage			$-0.3V_{DC}$ to $+32V_{DC}$
Power Dissipation(2)			830 mW
Output Short-Circuit to GND(3) (One Amplifier) $V^+ \le 15V_{DC}$ and $T_A = 25°C$			Continuous
Maximum Junction Temperature (T_{Jmax})			150°C
Input Current ($V_I < -0.3V$)(4)			50 mA
Operating Temperature Range			$-55°C \le T_A \le +125°C$
Storage Temperature Range			$-65°C \le T_A \le +150°C$
Lead Temperature (Soldering, 10 seconds)		TO-99	300°C
		CDIP	260°C
		CLGA	260°C
Thermal Resistance	θ_{JA}	TO-99 (Still Air)	155°C/W
		TO-99 (500LF/Min Air Flow)	80°C/W
		CDIP (Still Air)	132°C/W
		CDIP (500LF/Min Air Flow)	81°C/W
		CLGA (Still Air)	195°C/W
		CLGA (500LF/Min Air Flow)	131°C/W
	θ_{JC}	TO-99	42°C/W
		CDIP	23°C/W
		CLGA	33°C/W
Package Weight	TO-99		1,000mg
	CDIP		1,100mg
	CLGA		220mg
ESD Tolerance(5)			250V

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

(2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.

(3) Short circuits from the output to V^+ can cause excessive heating and eventual destruction. When considering short circuits to ground, the maximum output current is approximately 40 mA independent of the magnitude of V^+. At values of supply voltage in excess of +15V, continuous short-circuits can exceed the power dissipation ratings and cause eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.

(4) This input current will only exist when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistors becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also lateral NPN parasitic transistor action on the IC chip. This transistor action can cause the output voltages of the op amps to go to the V^+voltage level (or to ground for a large overdrive) for the time duration that an input is driven negative. This is not destructive and normal output states will re-establish when the input voltage, which was negative, again returns to a value greater than −0.3V (at 25°C).

(5) Human body model, 1.5 kΩ in series with 100 pF.

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Quality Conformance Inspection

Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55
12	Settling time at	+25
13	Settling time at	+125
14	Settling time at	-55

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LM158 Electrical Characteristics SMD 5962–8771001 DC Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
I_{CC}	Power Supply Current	$+V_{CC}$ = 5V, R_L = 100K, V_O = 1.4V			1.2	mA	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 100K, V_O = 1.4V			3.0	mA	1
					4.0	mA	2, 3
V_{OH}	Output Voltage High	$+V_{CC}$ = 30V, R_L = 2KΩ		26		V	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 10KΩ		27		V	1, 2, 3
V_{OL}	Output Voltage Low	$+V_{CC}$ = 30V, R_L = 10KΩ			20	mV	1, 2, 3
		$+V_{CC}$ = 30V, I_{Sink} = 1µA			20	mV	1, 2, 3
		$+V_{CC}$ = 5V, R_L = 10KΩ			20	mV	1, 2, 3
I_{Sink}	Output Sink Current	$+V_{CC}$ = 15V, V_O = 200mV, $+V_I$ = 0V, $-V_I$ = +65mV		12		µA	1
		$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = +65mV		10		mA	1
				5.0		mA	2, 3
I_{Source}	Output Source Current	$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = -65mV			-20	mA	1
					-10	mA	2, 3
I_{OS}	Short Circuit Current	$+V_{CC}$ = 5V, V_O = 0V		-60		mA	1
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-5.0	5.0	mV	1
				-7.0	7.0	mV	2, 3
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V		-5.0	5.0	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28V, R_S = 50Ω, V_O = 1.4V		-7.0	7.0	mV	2, 3
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-5.0	5.0	mV	1
				-7.0	7.0	mV	2, 3
CMRR	Common Mode Rejection Ratio	$+V_{CC}$ = 30V, R_S = 50Ω V_I = 0V to 28.5V,		70		dB	1
$\pm I_{IB}$	Input BIas Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)	-150	-1.0	nA	1
			See (1)	-300	-1.0	nA	2, 3
I_{IO}	Input Offset Current	$+V_{CC}$ = 5V, V_{CM} = 0V		-30	30	nA	1
				-100	100	nA	2, 3
PSRR	Power Supply Rejection Ratio	$+V_{CC}$ = 5V to 30V, V_{CM} = 0V		65		dB	1
V_{CM}	Common Mode Voltage Range	$+V_{CC}$ = 30V	See (2), (3)		28.5	V	1
			See (2), (3)		28.0	V	2, 3
V_{Diff}	Differential Input Voltage		See (4)		32	V	1, 2, 3
A_{VS}	Large Signal Gain	$+V_{CC}$ = 15V, R_L = 2KΩ, V_O = 1V to 11V		50		V/mV	4
				25		V/mV	5, 6

(1) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
(2) The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3V (at 25°C). The upper end of the common-mode voltage range is V^+ −1.5V (at 25°C), but either or both inputs can go to +32V without damage, independent of the magnitude of V^+.
(3) Specified by input offset voltage.
(4) Specified parameter not tested.

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LM158A Electrical Characteristics SMD 5962–8771002, High Dose Rate DC Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
I_{CC}	Power Supply Current	$+V_{CC}$ = 5V, R_L = 100K, V_O = 1.4V			1.2	mA	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 100K, V_O = 1.4V			3.0	mA	1
					4.0	mA	2, 3
V_{OH}	Output Voltage High	$+V_{CC}$ = 30V, R_L = 2KΩ		26		V	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 10KΩ		27		V	1, 2, 3
V_{OL}	Output Voltage Low	$+V_{CC}$ = 30V, R_L = 10KΩ			40	mV	1
					100	mV	2, 3
		$+V_{CC}$ = 30V, I_{Sink} = 1µA			40	mV	1
					100	mV	2, 3
		$+V_{CC}$ = 5V, R_L = 10KΩ			40	mV	1
					100	mV	2, 3
I_{Sink}	Output Sink Current	$+V_{CC}$ = 15V, V_O = 200mV, $+V_I$ = 0V, $-V_I$ = +65mV		12		µA	1
		$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = +65mV		10		mA	1
				5.0		mA	2, 3
I_{Source}	Output Source Current	$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = -65mV			-20	mA	1
					-10	mA	2, 3
I_{OS}	Short Circuit Current	$+V_{CC}$ = 5V, V_O = 0V		-60		mA	1
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
				-4.0	4.0	mV	2, 3
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28V, R_S = 50Ω, V_O = 1.4V		-4.0	4.0	mV	2, 3
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
				-4.0	4.0	mV	2, 3
CMRR	Common Mode Rejection Ratio	$+V_{CC}$ = 30V, R_S = 50Ω V_I = 0V to 28.5V,		70		dB	1
$\pm I_{IB}$	Input BIas Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)	-50	-1.0	nA	1
			See (1)	-100	-1.0	nA	2, 3
I_{IO}	Input Offset Current	$+V_{CC}$ = 5V, V_{CM} = 0V		-10	10	nA	1
				-30	30	nA	2, 3
PSRR	Power Supply Rejection Ratio	$+V_{CC}$ = 5V to 30V, V_{CM} = 0V		65		dB	1
V_{CM}	Common Mode Voltage Range	$+V_{CC}$ = 30V	See (2) (3)		28.5	V	1
			See (2) (3)		28.0	V	2, 3
V_{Diff}	Differential Input Voltage		See (4)		32	V	1, 2, 3
A_{VS}	Large Signal Gain	$+V_{CC}$ = 15V, R_L = 2KΩ, V_O = 1V to 11V		50		V/mV	4
				25		V/mV	5, 6

(1) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
(2) The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3V (at 25°C). The upper end of the common-mode voltage range is V^+ −1.5V (at 25°C), but either or both inputs can go to +32V without damage, independent of the magnitude of V^+.
(3) Specified by input offset voltage.
(4) Specified parameter not tested.

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SMD 5962–8771002, High Dose Rate DC Drift Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground. Delta calculations are performed on QMLV devices at Group B, Subgroup 5 only.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1
$\pm I_{IB}$	Input Bias Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)	-10	10	nA	1

(1) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.

SMD 5962–8771002, High Dose Rate SMD 5962–8771002, High Dose Rate 100K Post Radiation Limits @ +25°C (1) DC Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub - groups
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
$\pm I_{IB}$	Input Bias Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)(2)	-60	-1.0	nA	1
I_{CC}	Power Supply Current	$+V_{CC}$ = 5V, R_L = 100K, V_O = 1.4V	See (1)		1.5	mA	1

(1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate sensitivity. Radiation end point limits for the noted parameters are specified only for the conditions as specified in MIL-STD-883, per Test Method 1019, Condition A.
(2) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.

LM158A Electrical Characteristics SMD 5962–8771003 ELDRS Free Only DC Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
I_{CC}	Power Supply Current	$+V_{CC}$ = 5V, R_L = 100K, V_O = 1.4V			1.2	mA	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 100K, V_O = 1.4V			3.0	mA	1,
					4.0		2, 3
V_{OH}	Output Voltage High	$+V_{CC}$ = 30V, R_L = 2KΩ		26		V	1, 2, 3
		$+V_{CC}$ = 30V, R_L = 10KΩ		27		V	1, 2, 3
V_{OL}	Output Voltage Low	$+V_{CC}$ = 30V, R_L = 10KΩ			40	mV	1
					100	mV	2, 3
		$+V_{CC}$ = 30V, I_{Sink} = 1µA			40	mV	1
					100	mV	2, 3
		$+V_{CC}$ = 5V, R_L = 10KΩ			40	mV	1
					100	mV	2, 3

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LM158A Electrical Characteristics SMD 5962–8771003 ELDRS Free Only DC Parameters (continued)

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
I_{Sink}	Output Sink Current	$+V_{CC}$ = 15V, V_O = 200mV, $+V_I$ = 0V, $-V_I$ = +65mV		12		µA	1
		$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = +65mV		10		mA	1
				5.0		mA	2, 3
I_{Source}	Output Source Current	$+V_{CC}$ = 15V, V_O = 2V, $+V_I$ = 0V, $-V_I$ = -65mV			-20	mA	1
					-10	mA	2, 3
I_{OS}	Short Circuit Current	$+V_{CC}$ = 5V, V_O = 0V		-60		mA	1
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
				-4.0	4.0	mV	2, 3
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28V, R_S = 50Ω, V_O = 1.4V		-4.0	4.0	mV	2, 3
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-2.0	2.0	mV	1
				-4.0	4.0	mV	2, 3
CMRR	Common Mode Rejection Ratio	$+V_{CC}$ = 30V, R_S = 50Ω V_I = 0V to 28.5V,		70		dB	1
$\pm I_{IB}$	Input BIas Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)	-50	-1.0	nA	1
			See (1)	-100	-1.0	nA	2, 3
I_{IO}	Input Offset Current	$+V_{CC}$ = 5V, V_{CM} = 0V		-10	10	nA	1
				-30	30	nA	2, 3
PSRR	Power Supply Rejection Ratio	$+V_{CC}$ = 5V to 30V, V_{CM} = 0V		65		dB	1
V_{CM}	Common Mode Voltage Range	$+V_{CC}$ = 30V	See (2), (3)		28.5	V	1
			See (2), (3)		28.0	V	2, 3
V_{Diff}	Differential Input Voltage		See (4)		32	V	1, 2, 3
A_{VS}	Large Signal Gain	$+V_{CC}$ = 15V, R_L = 2KΩ, V_O = 1V to 11V		50		V/mV	4
				25		V/mV	5, 6

(1) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
(2) The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3V (at 25°C). The upper end of the common-mode voltage range is V^+ −1.5V (at 25°C), but either or both inputs can go to +32V without damage, independent of the magnitude of V^+.
(3) Specified by input offset voltage.
(4) Specified parameter not tested.

SMD 5962–8771003 ELDRS Free Only DC Drift Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.
Delta calculations are performed on QMLV devices at Group B, Subgroup 5 only.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V		-0.5	0.5	mV	1

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SMD 5962–8771003 ELDRS Free Only DC Drift Parameters (continued)

The following conditions apply, unless otherwise specified. All voltages referenced to device ground. Delta calculations are performed on QMLV devices at Group B, Subgroup 5 only.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub-groups
$\pm I_{IB}$	Input Bias Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1)	-10	10	nA	1

(1) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.

SMD 5962–8771003 ELDRS Free Only 100K Post Radiation Limits @ +25°C (1) DC Parameters

The following conditions apply, unless otherwise specified. All voltages referenced to device ground.

Parameter		Test Conditions	Notes	Min	Max	Units	Sub - groups
V_{IO}	Input Offset Voltage	$+V_{CC}$ = 30V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
		$+V_{CC}$ = 30V, V_{CM} = 28.5V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
		$+V_{CC}$ = 5V, V_{CM} = 0V, R_S = 50Ω, V_O = 1.4V	See (1)	-4.0	4.0	mV	1
$\pm I_{IB}$	Input Bias Current	$+V_{CC}$ = 5V, V_{CM} = 0V	See (1) (2)	-60	-1.0	nA	1

(1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be sensitive in a high dose environment. Low dose rate testing has been performed on a wafer-by-wafer basis, per Test Method 1019, Condition D of MIL-STD-883, with no enhanced low dose rate sensitivity (ELDRS).

(2) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.

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Typical Performance Characteristics

Input Voltage Range

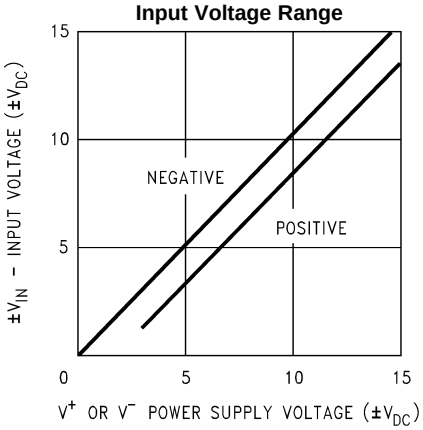


Figure 4.

Input Current

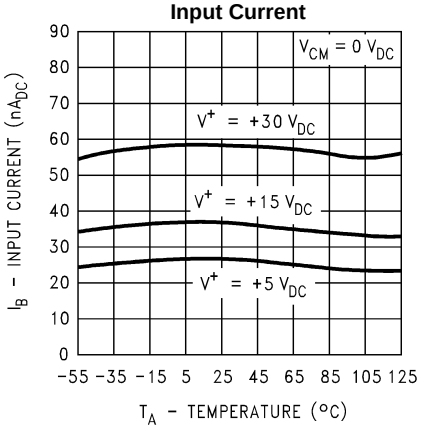


Figure 5.

Supply Current

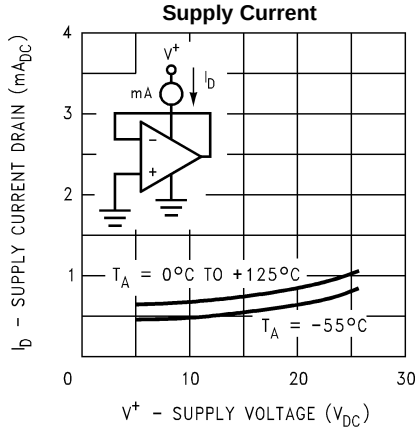


Figure 6.

Voltage Gain

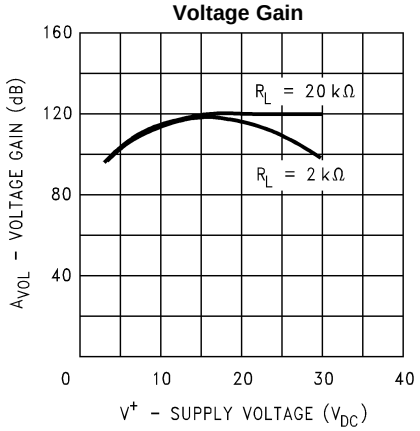


Figure 7.

Open Loop Frequency Response

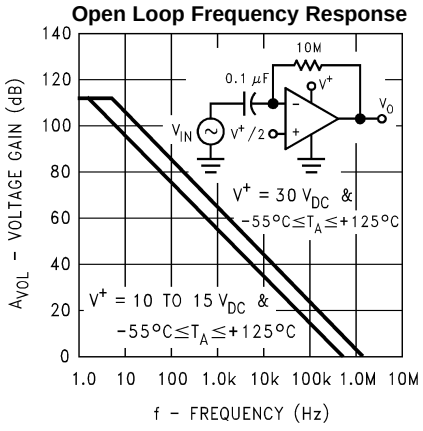


Figure 8.

Common-Mode Rejection Ratio

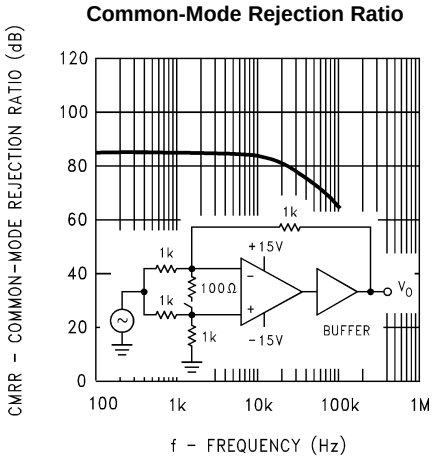


Figure 9.

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Typical Performance Characteristics (continued)

Voltage Follower Pulse Response

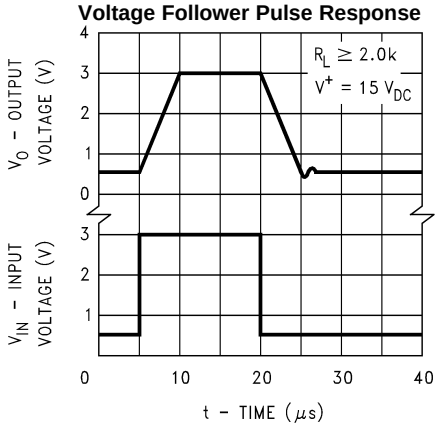


Figure 10.

Voltage Follower Pulse Response (Small Signal)

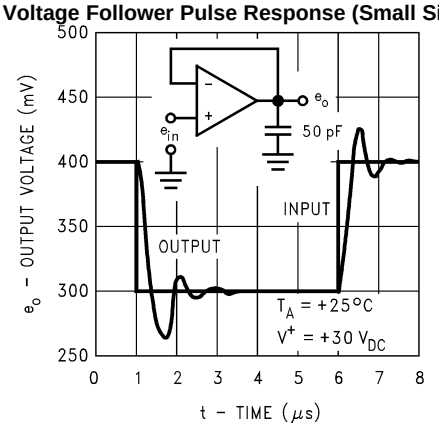


Figure 11.

Large Signal Frequency Response

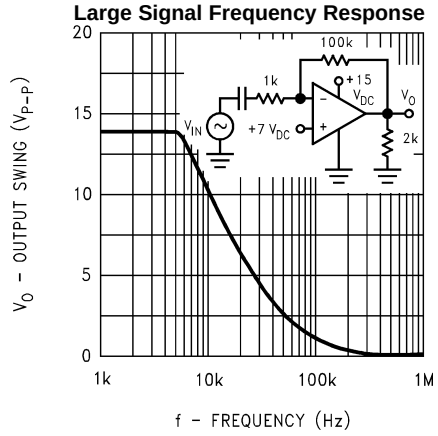


Figure 12.

Output Characteristics Current Sourcing

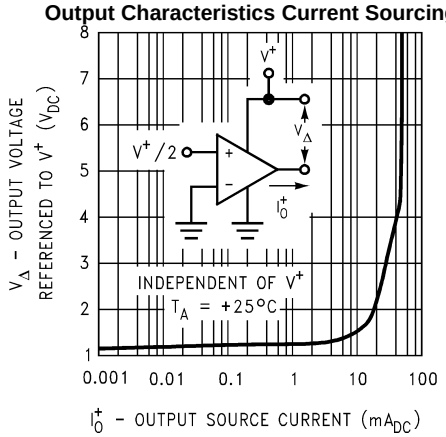


Figure 13.

Output Characteristics Current Sinking

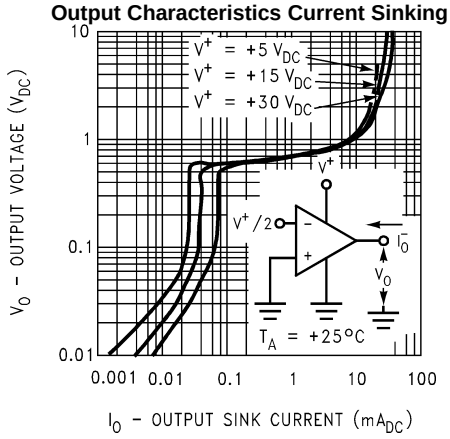


Figure 14.

Current Limiting

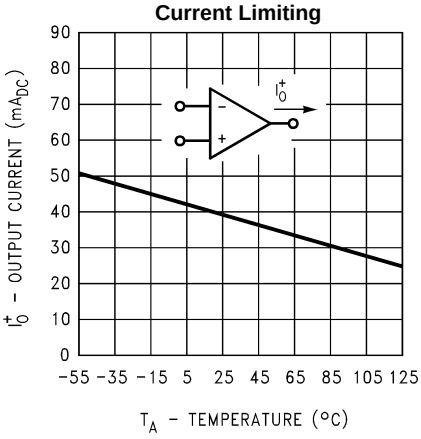


Figure 15.

APPLICATION HINTS

The LM158 series are op amps which operate with only a single power supply voltage, have true-differential inputs, and remain in the linear mode with an input common-mode voltage of 0 V_{DC}. These amplifiers operate over a wide range of power supply voltage with little change in performance characteristics. At 25°C amplifier operation is possible down to a minimum supply voltage of 2.3 V_{DC}.

Precautions should be taken to insure that the power supply for the integrated circuit never becomes reversed in polarity or that the unit is not inadvertently installed backwards in a test socket as an unlimited current surge through the resulting forward diode within the IC could cause fusing of the internal conductors and result in a destroyed unit.

Large differential input voltages can be easily accommodated and, as input differential voltage protection diodes are not needed, no large input currents result from large differential input voltages. The differential input voltage may be larger than V^+ without damaging the device. Protection should be provided to prevent the input voltages from going negative more than −0.3 V_{DC} (at 25°C). An input clamp diode with a resistor to the IC input terminal can be used.

To reduce the power supply current drain, the amplifiers have a class A output stage for small signal levels which converts to class B in a large signal mode. This allows the amplifiers to both source and sink large output currents. Therefore both NPN and PNP external current boost transistors can be used to extend the power capability of the basic amplifiers. The output voltage needs to raise approximately 1 diode drop above ground to bias the on-chip vertical PNP transistor for output current sinking applications.

For ac applications, where the load is capacitively coupled to the output of the amplifier, a resistor should be used, from the output of the amplifier to ground to increase the class A bias current and prevent crossover distortion. Where the load is directly coupled, as in dc applications, there is no crossover distortion.

Capacitive loads which are applied directly to the output of the amplifier reduce the loop stability margin. Values of 50 pF can be accommodated using the worst-case non-inverting unity gain connection. Large closed loop gains or resistive isolation should be used if larger load capacitance must be driven by the amplifier.

The bias network of the LM158 establishes a drain current which is independent of the magnitude of the power supply voltage over the range of 3 V_{DC} to 30 V_{DC}.

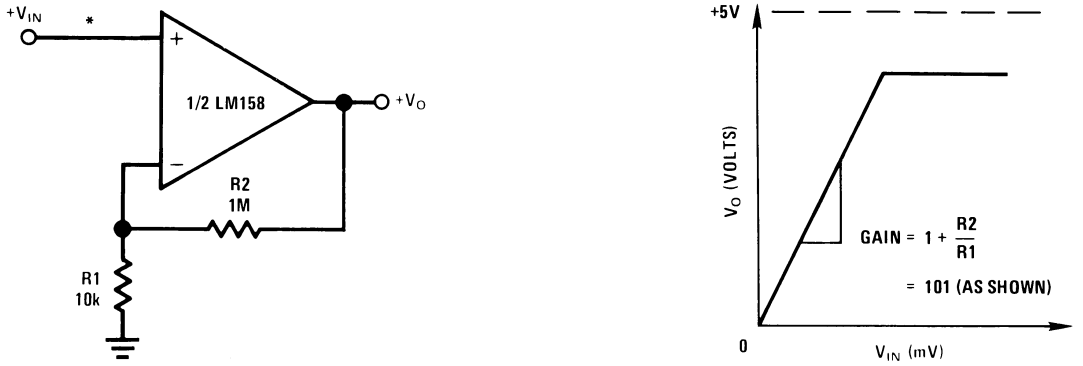
Output short circuits either to ground or to the positive power supply should be of short time duration. Units can be destroyed, not as a result of the short circuit current causing metal fusing, but rather due to the large increase in IC chip dissipation which will cause eventual failure due to excessive junction temperatures. Putting direct short-circuits on more than one amplifier at a time will increase the total IC power dissipation to destructive levels, if not properly protected with external dissipation limiting resistors in series with the output leads of the amplifiers. The larger value of output source current which is available at 25°C provides a larger output current capability at elevated temperatures (see Typical Performance Characteristics) than a standard IC op amp.

The circuits presented in the section on typical applications emphasize operation on only a single power supply voltage. If complementary power supplies are available, all of the standard op amp circuits can be used. In general, introducing a pseudo-ground (a bias voltage reference of $V^+/2$) will allow operation above and below this value in single power supply systems. Many application circuits are shown which take advantage of the wide input common-mode voltage range which includes ground. In most cases, input biasing is not required and input voltages which range to ground can easily be accommodated.

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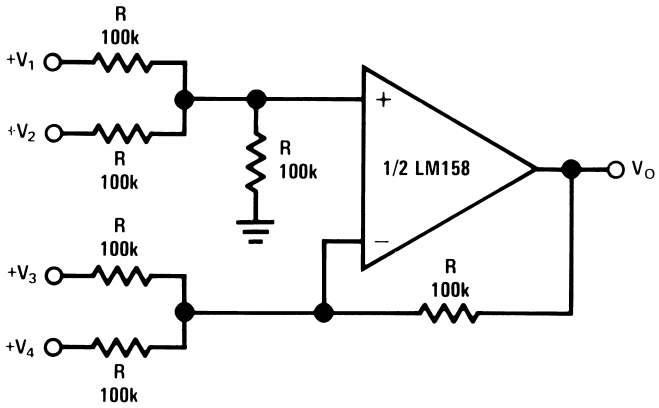
Typical Single-Supply Applications

(V^+ = 5.0 V_{DC})



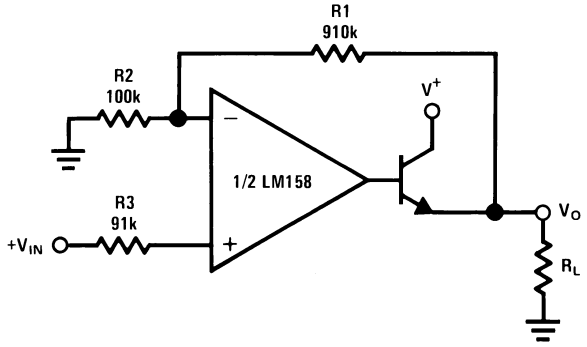
*R not needed due to temperature independent I_{IN}

Figure 16. Non-Inverting DC Gain (0V Output)



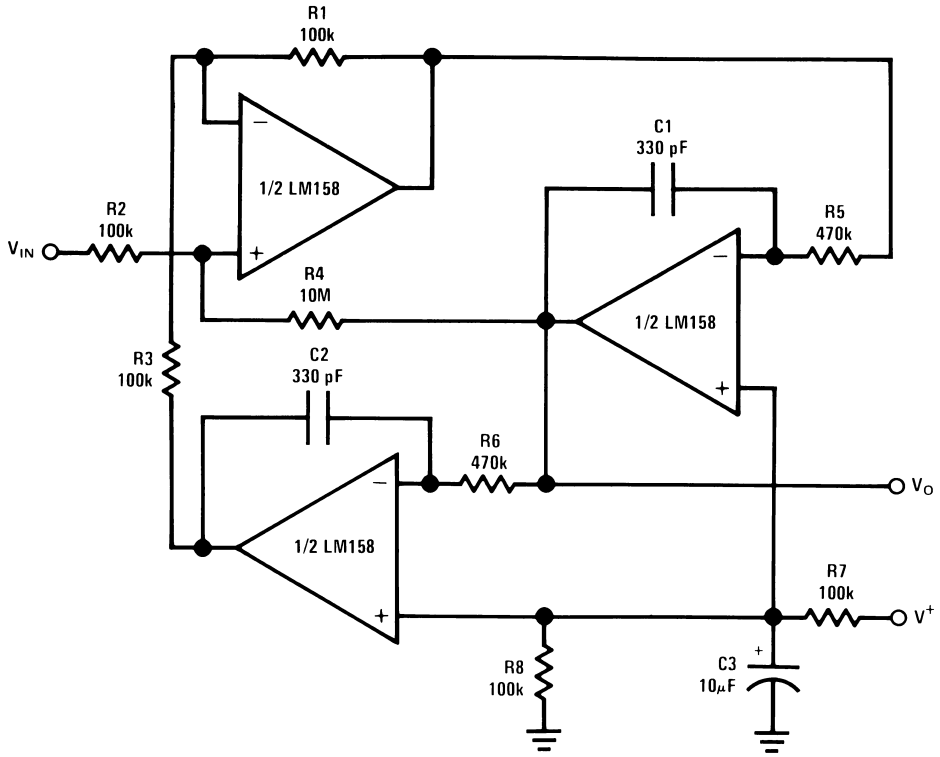
Where: $V_O = V_1 + V_2 - V_3 - V_4$
$(V_1 + V_2) \geq (V_3 + V_4)$ to keep $V_O > 0$ V_{DC}

Figure 17. DC Summing Amplifier ($V_{IN'S} \geq 0$ V_{DC} and $V_O \geq 0$ V_{DC})



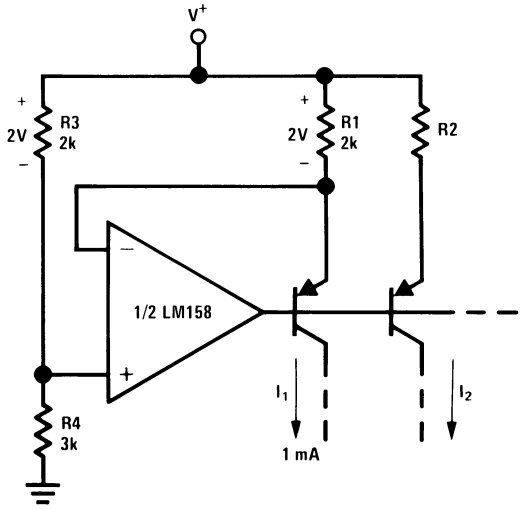
V_O = 0 V_{DC} for V_{IN} = 0 V_{DC}
A_V = 10

Figure 18. Power Amplifier



f_o = 1 kHz
Q = 50
A_V = 100 (40 dB)

Figure 19. "BI-QUAD" RC Active Bandpass Filter



$$I_2 = \left(\frac{R1}{R2}\right) I_1$$

Figure 20. Fixed Current Sources

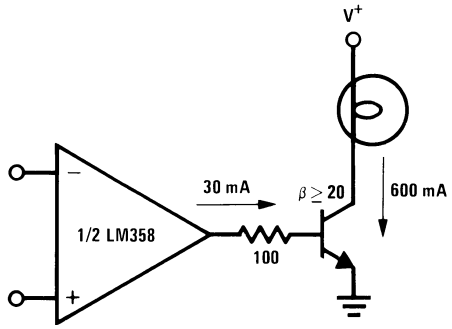


Figure 21. Lamp Driver

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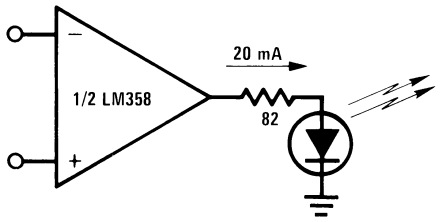
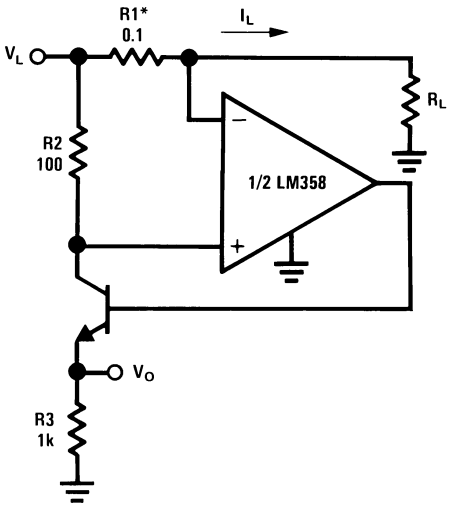


Figure 22. LED Driver



$$V_O = \frac{1V\ (I_L)}{1A}$$

*(Increase R1 for I_L small)

$V_L \leq V^+ - 2V$

Figure 23. Current Monitor

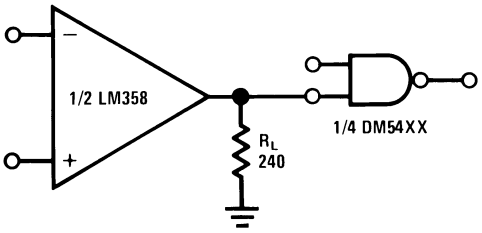
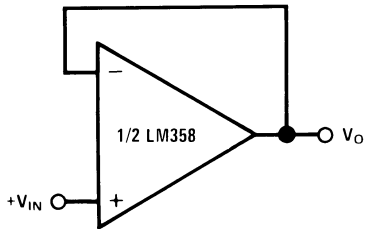


Figure 24. Driving TTL



$V_O = V_{IN}$

Figure 25. Voltage Follower

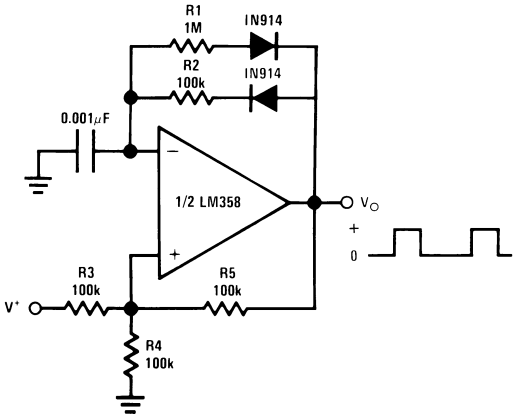


Figure 26. Pulse Generator

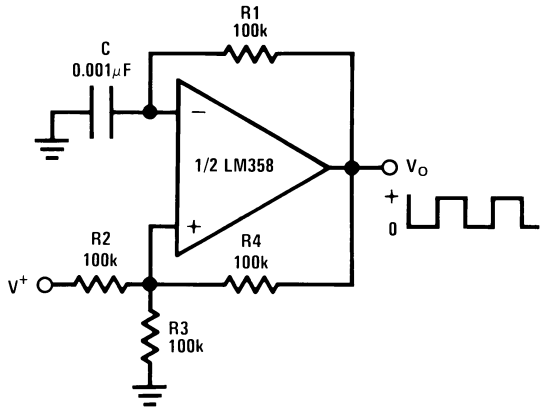


Figure 27. Squarewave Oscillator

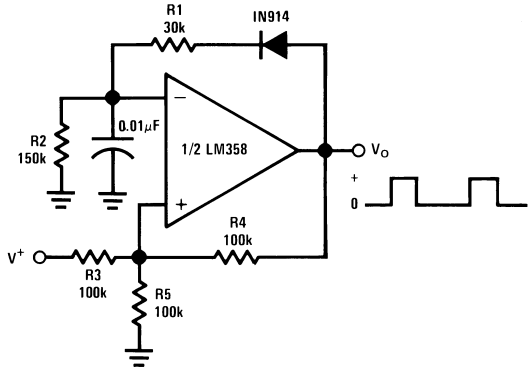
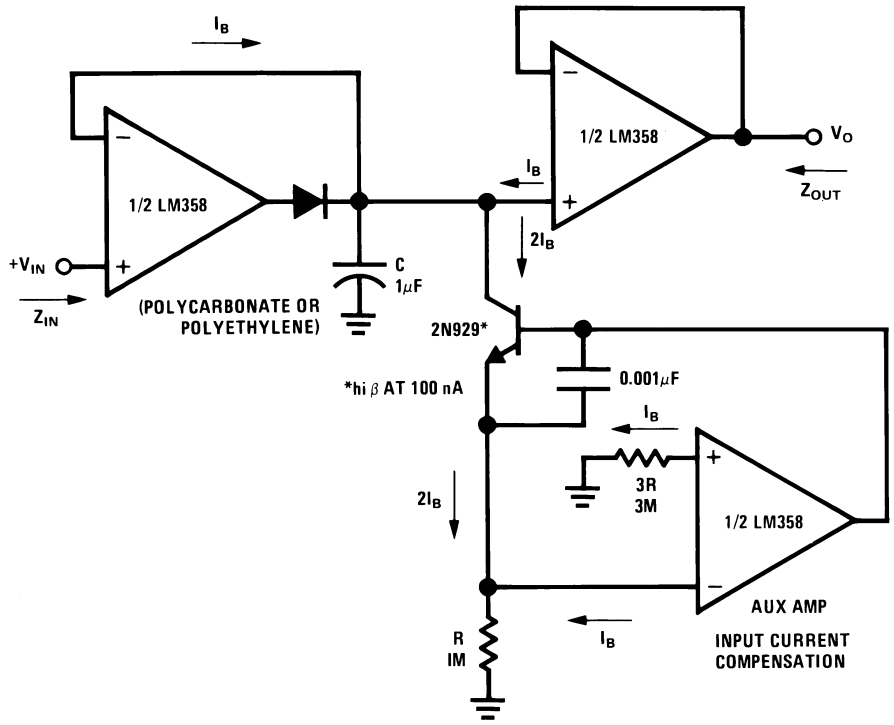


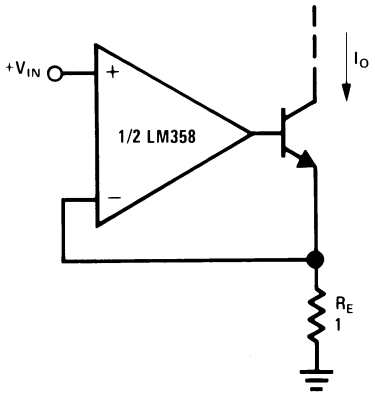
Figure 28. Pulse Generator



HIGH Z_{IN}
LOW Z_{OUT}

Figure 29. Low Drift Peak Detector

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I_O = 1 amp/volt V_{IN}
(Increase R_E for I_O small)

Figure 30. High Compliance Current Sink

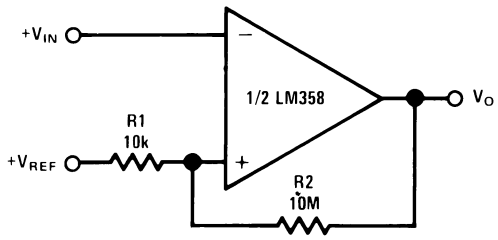
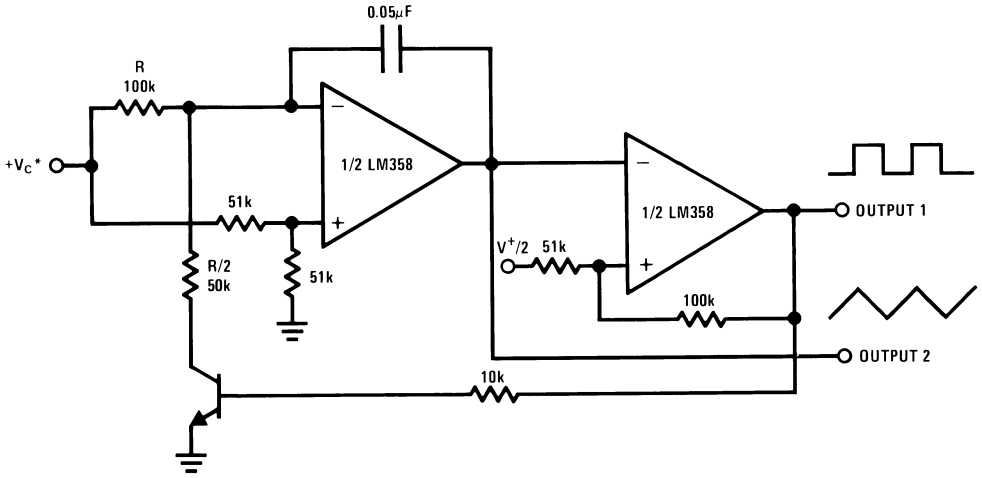
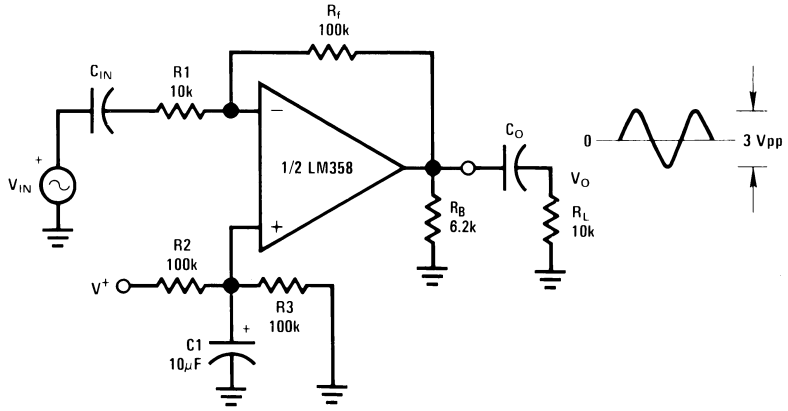


Figure 31. Comparator with Hysteresis



*WIDE CONTROL VOLTAGE RANGE: 0 $V_{DC} \leq V_C \leq 2$ ($V^+ - 1.5V_{DC}$)

Figure 32. Voltage Controlled Oscillator (VCO)



$$A_V = \frac{R_f}{R1} \text{ (As shown, } A_V = 10)$$

Figure 33. AC Coupled Inverting Amplifier

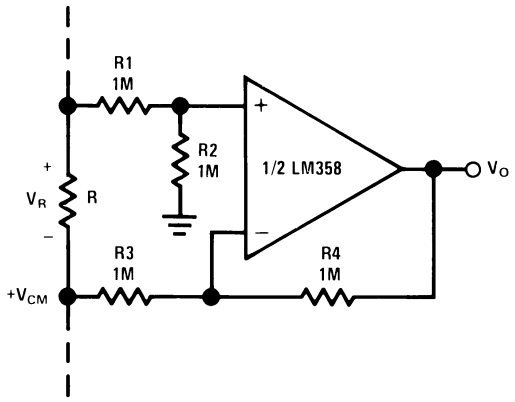
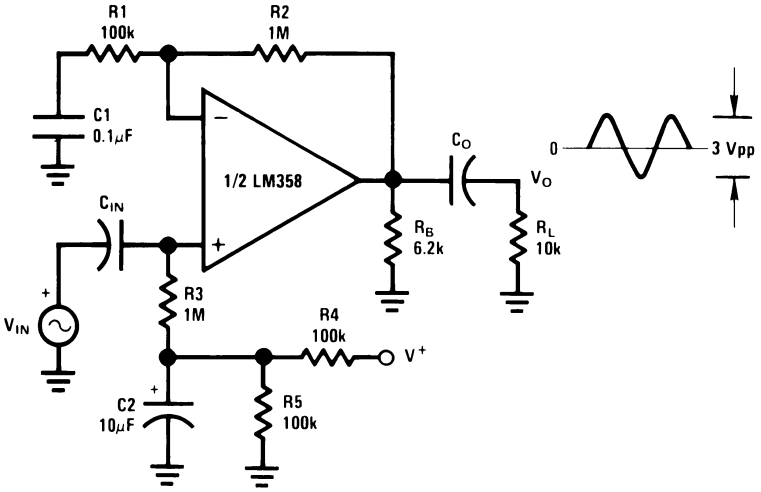


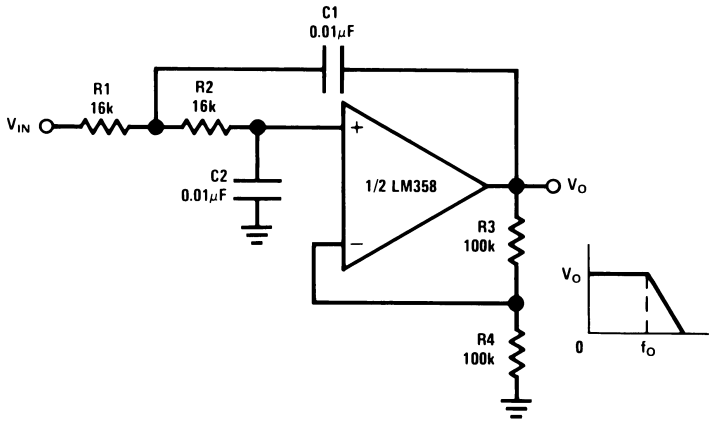
Figure 34. Ground Referencing a Differential Input Signal



$$A_V = 1 + \frac{R2}{R1}$$

A_V = 11 (As Shown)

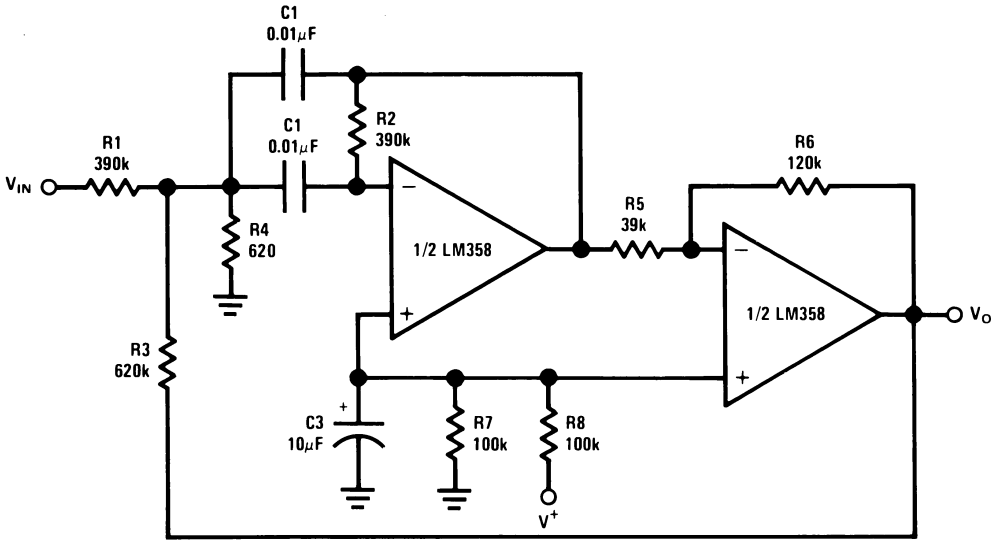
Figure 35. AC Coupled Non-Inverting Amplifier



f_o = 1 kHz
Q = 1
A_V = 2

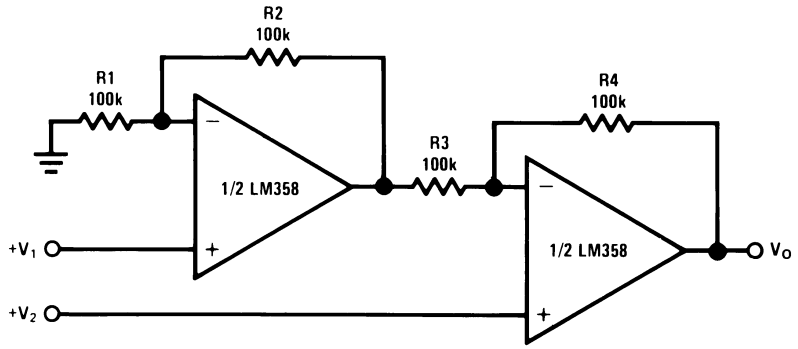
Figure 36. DC Coupled Low-Pass RC Active Filter

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f_o = 1 kHz
Q = 25

Figure 37. Bandpass Active Filter



For $\frac{R1}{R2} = \frac{R4}{R3}$ (CMRR depends on this resistor ratio match)

$V_O = 1 + \frac{R4}{R3}(V_2 - V_1)$

As Shown: $V_O = 2(V_2 - V_1)$

Figure 38. High Input Z, DC Differential Amplifier

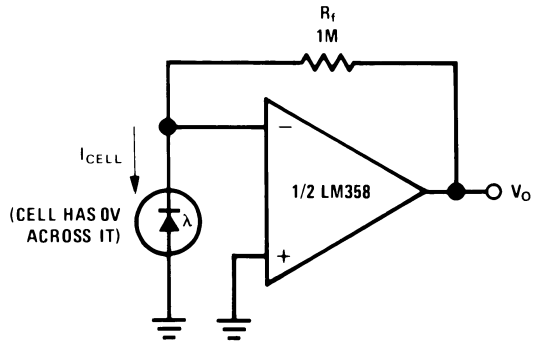
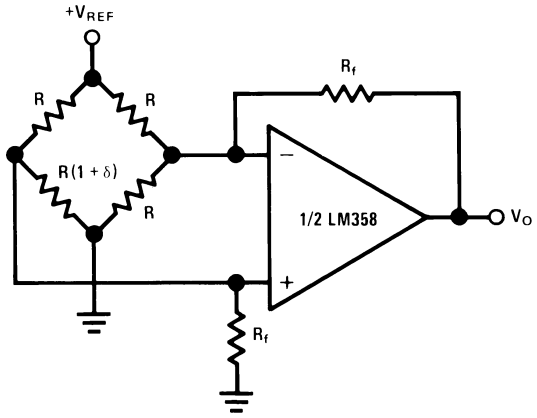


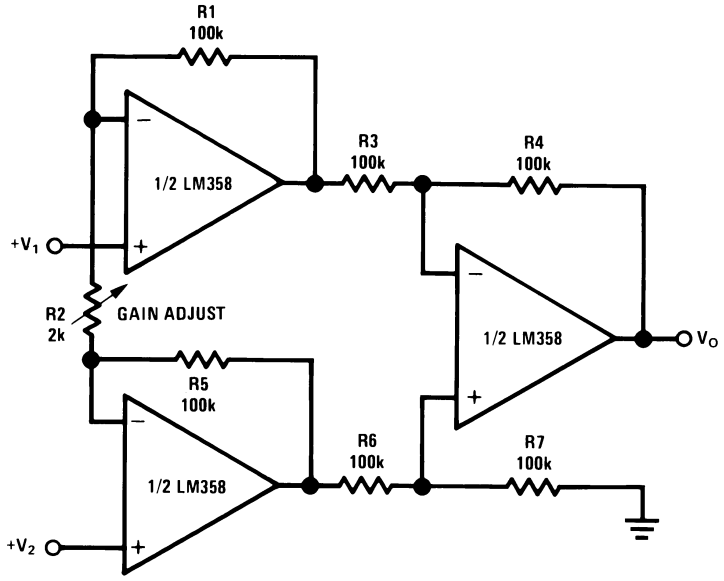
Figure 39. Photo Voltaic-Cell Amplifier



For $\delta << 1$ and $R_f >> R$

$$V_O \cong V_{REF}\left(\frac{\delta}{2}\right)\frac{R_f}{R}$$

Figure 40. Bridge Current Amplifier



If R1 = R5 & R3 = R4 = R6 = R7 (CMRR depends on match)

$$V_O = 1 + \frac{2R1}{R2}(V_2 - V_1)$$

As shown $V_O = 101\,(V_2 - V_1)$

Figure 41. High Input Z Adjustable-Gain DC Instrumentation Amplifier

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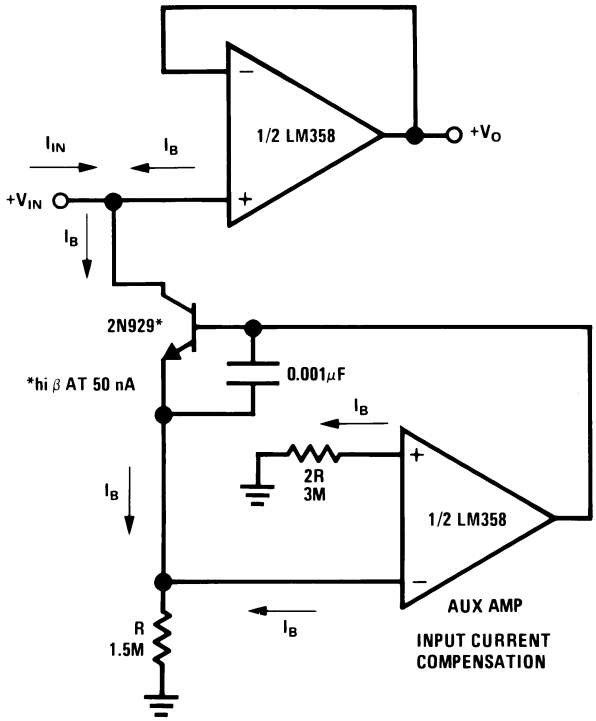


Figure 42. Using Symmetrical Amplifiers to Reduce Input Current (General Concept)

REVISION HISTORY

Changes from Revision E (March 2013) to Revision F	Page
• Changed layout of National Data Sheet to TI format	20

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-8771002GA	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AH-SMD 5962-8771002GA Q A CO 5962-8771002GA Q > T
5962-8771002QXA	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG /883 Q 5962-87710 (02QXA ACO, 02QYA ACO) (02QXA >T, 02QYA >T)
5962R8771002V9A	Active	Production	DIESALE (Y) | 0	38 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
5962R8771002VGA	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AHRQMLV 5962R8771002VGA Q ACO 5962R8771002VGA Q >T
5962R8771002VPA	Active	Production	CDIP (NAB) | 8	40 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AJRQMLV 5962R87710 02VPA Q ACO 02VPA Q >T
5962R8771002VXA	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG (RLQMLV Q, RQMLV Q) 5962R87710 02VXA ACO 02VXA >T
5962R8771003V9A	Active	Production	DIESALE (Y) | 0	456 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	25 to 25	
5962R8771003VGA	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AHRLQMLV 5962R8771003VGA Q ACO 5962R8771003VGA Q >T

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962R8771003VPA	Active	Production	CDIP (NAB) | 8	40 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AJRLQV 5962R87710 03VPA Q ACO 03VPA Q >T
5962R8771003VXA	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG RLQMLV Q 5962R87710 03VXA ACO 03VXA >T
LM158 MD8	Active	Production	DIESALE (Y) | 0	400 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM158A MDE	Active	Production	DIESALE (Y) | 0	456 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM158A MDR	Active	Production	DIESALE (Y) | 0	38 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM158AH-SMD	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AH-SMD 5962-8771002GA Q A CO 5962-8771002GA Q > T
LM158AH/883	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AH/883 Q ACO LM158AH/883 Q >T
LM158AHRLQMLV	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	No	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AHRLQMLV 5962R8771003VGA Q ACO 5962R8771003VGA Q >T
LM158AHRQMLV	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	No	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158AHRQMLV 5962R8771002VGA Q ACO 5962R8771002VGA Q >T
LM158AJ/883	Active	Production	CDIP (NAB) | 8	40 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AJ/883 5962-87710 02PA Q ACO 02PA Q >T
LM158AJRLQMLV	Active	Production	CDIP (NAB) | 8	40 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AJRLQV 5962R87710 03VPA Q ACO 03VPA Q >T

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM158AJRQMLV	Active	Production	CDIP (NAB) | 8	40 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AJRQMLV 5962R87710 02VPA Q ACO 02VPA Q >T
LM158AWG/883	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG /883 Q 5962-87710 (02QXA ACO, 02QYA ACO) (02QXA >T, 02QYA >T)
LM158AWGRLQMLV	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG RLQMLV Q 5962R87710 03VXA ACO 03VXA >T
LM158AWGRQMLV	Active	Production	CFP (NAC) | 10	124 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM158AWG (RLQMLV Q, RQMLV Q) 5962R87710 02VXA ACO 02VXA >T
LM158H/883	Active	Production	TO-99 (LMC) | 8	20 | JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	LM158H/883 Q ACO LM158H/883 Q >T

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

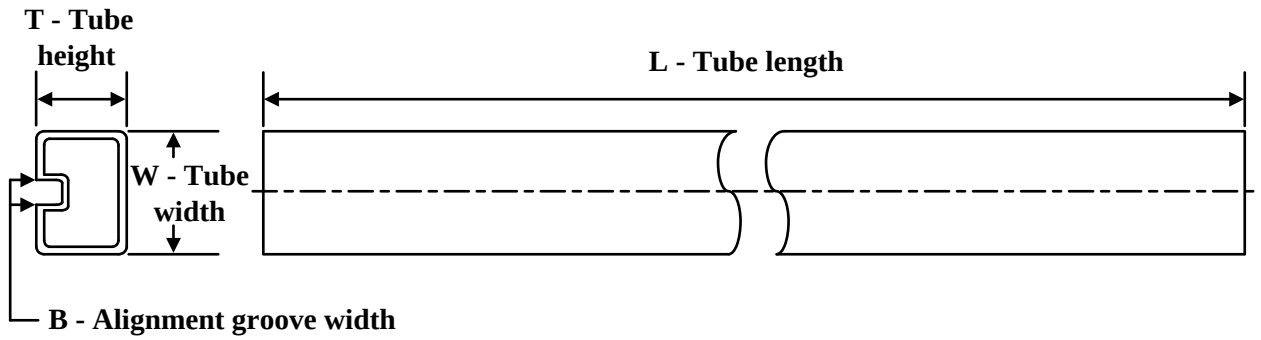
OTHER QUALIFIED VERSIONS OF LM158QML, LM158QML-SP :

- Military : LM158QML
- Space : LM158QML-SP

NOTE: Qualified Version Definitions:

- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

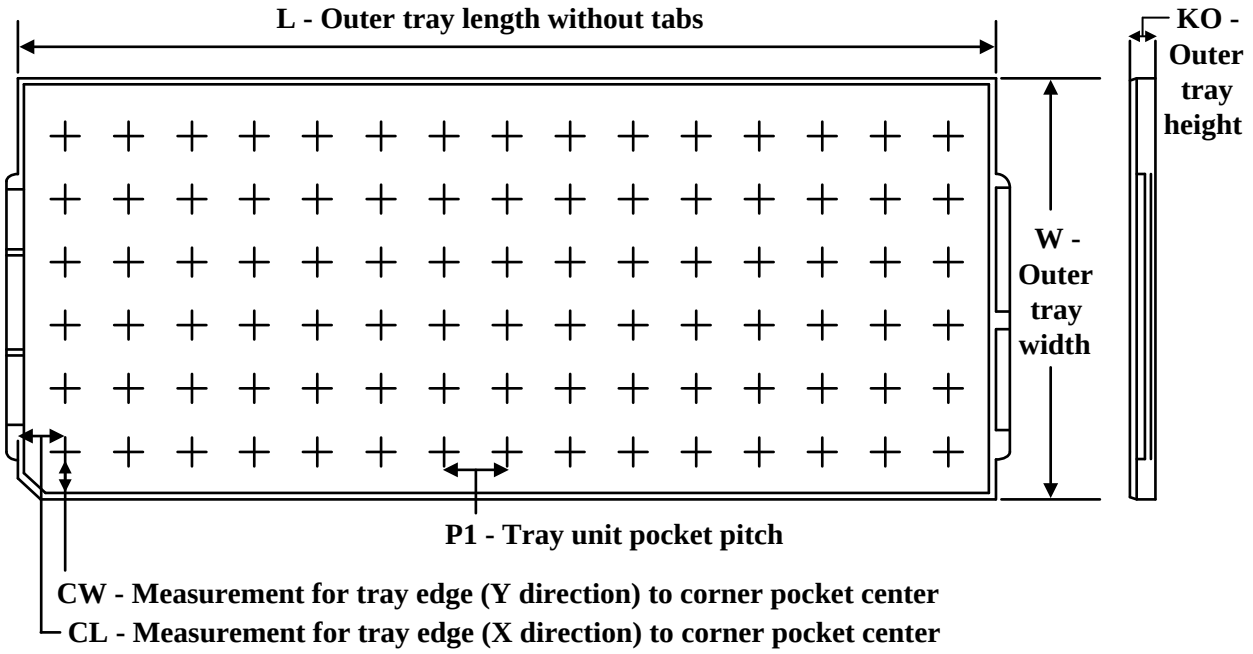
TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962R8771002VPA	NAB	CDIP	8	40	506.98	15.24	13440	NA
5962R8771003VPA	NAB	CDIP	8	40	506.98	15.24	13440	NA
LM158AJ/883	NAB	CDIP	8	40	506.98	15.24	13440	NA
LM158AJRLQMLV	NAB	CDIP	8	40	506.98	15.24	13440	NA
LM158AJRQMLV	NAB	CDIP	8	40	506.98	15.24	13440	NA

TRAY

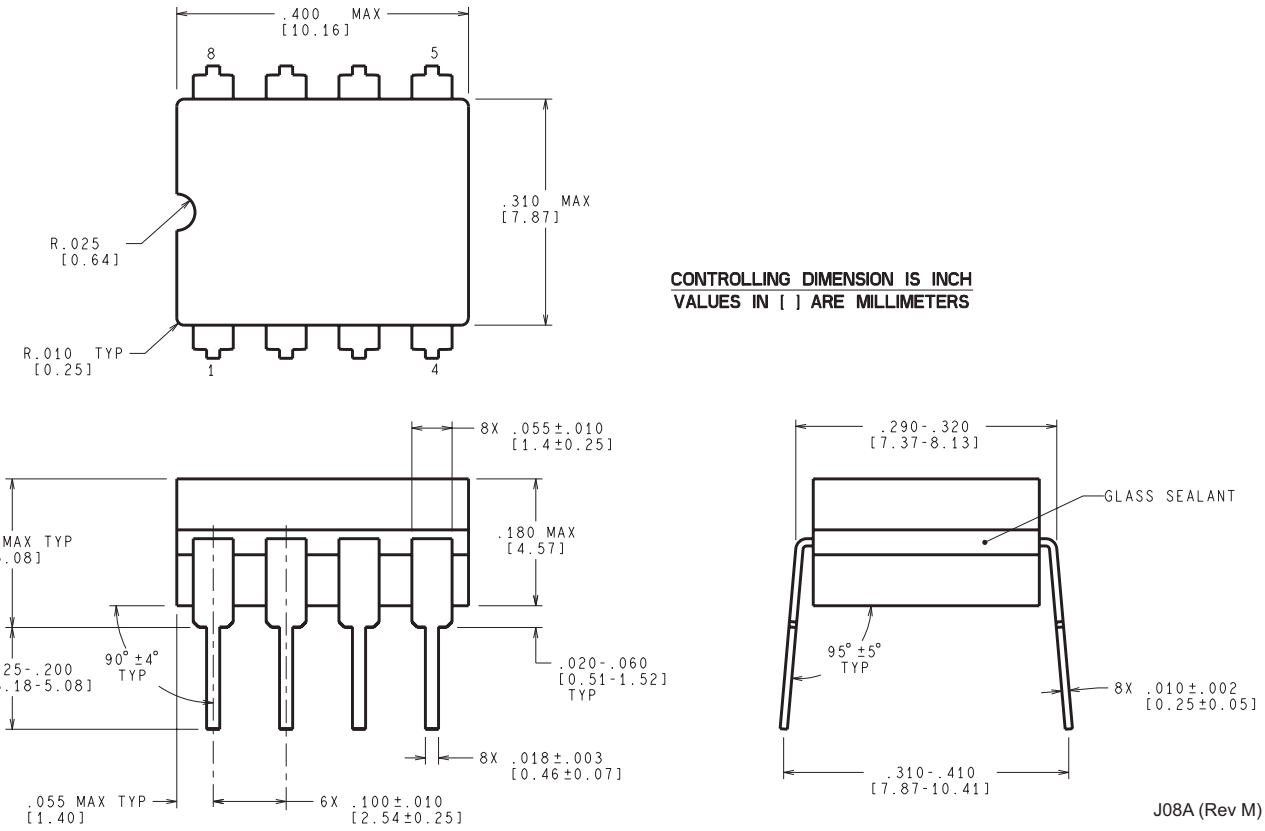


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
5962-8771002GA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
5962R8771002VGA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
5962R8771003VGA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM158AH-SMD	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM158AH/883	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM158AHRLQMLV	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM158AHRQMLV	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LM158H/883	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54

NAB0008A

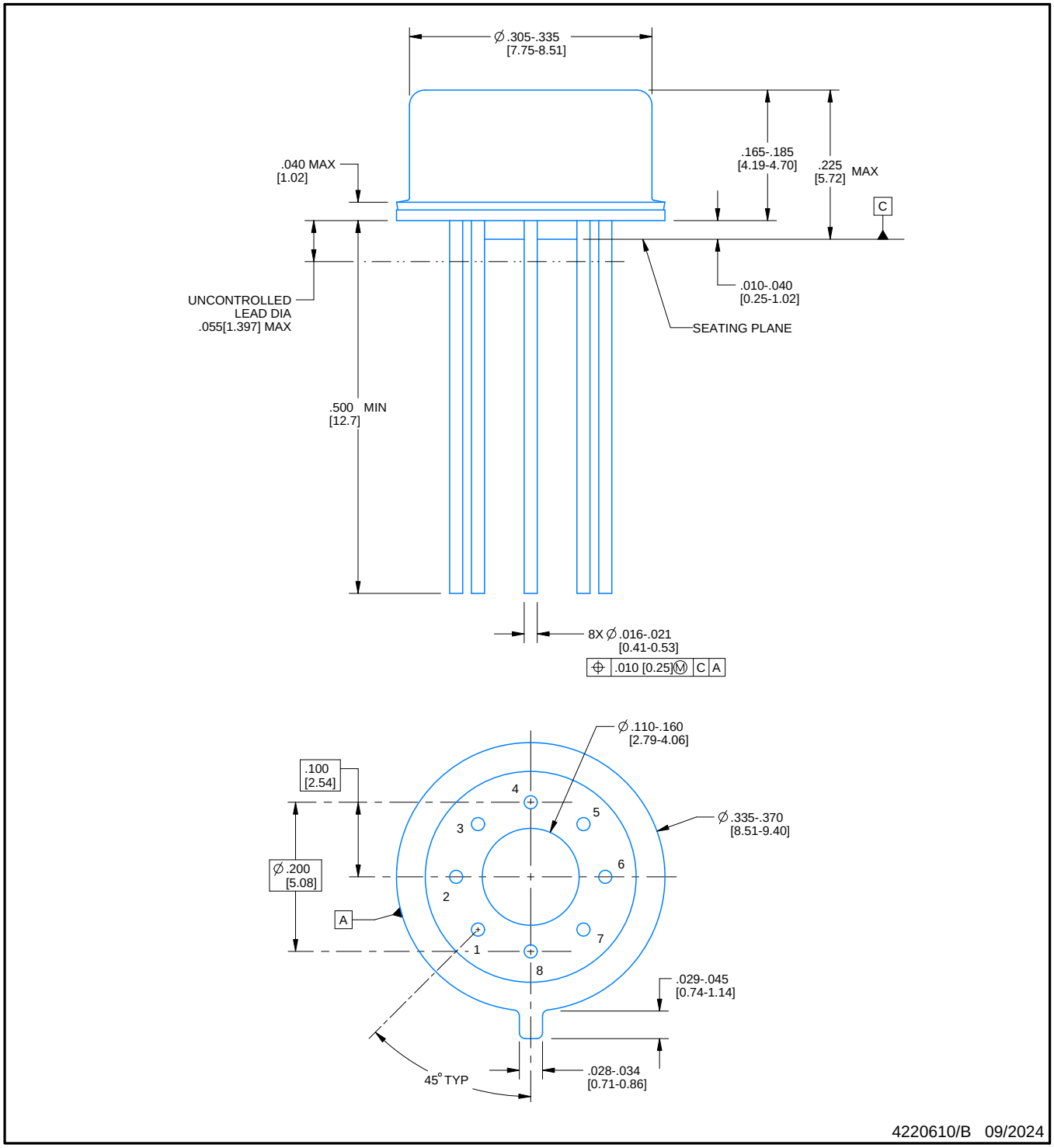

.400 MAX
[10.16]
8
5
.310 MAX
[7.87]
R.025
[0.64]
R.010 TYP
[0.25]
1
4
CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS
8X .055±.010
[1.4±0.25]
.200 MAX TYP
[5.08]
.180 MAX
[4.57]
8X .125-.200
[3.18-5.08]
90° ±4°
TYP
.020-.060
[0.51-1.52]
TYP
8X .018±.003
[0.46±0.07]
.055 MAX TYP
[1.40]
6X .100±.010
[2.54±0.25]
.290-.320
[7.37-8.13]
GLASS SEALANT
95° ±5°
TYP
8X .010±.002
[0.25±0.05]
.310-.410
[7.87-10.41]
J08A (Rev M)

PACKAGE OUTLINE

LMC0008A

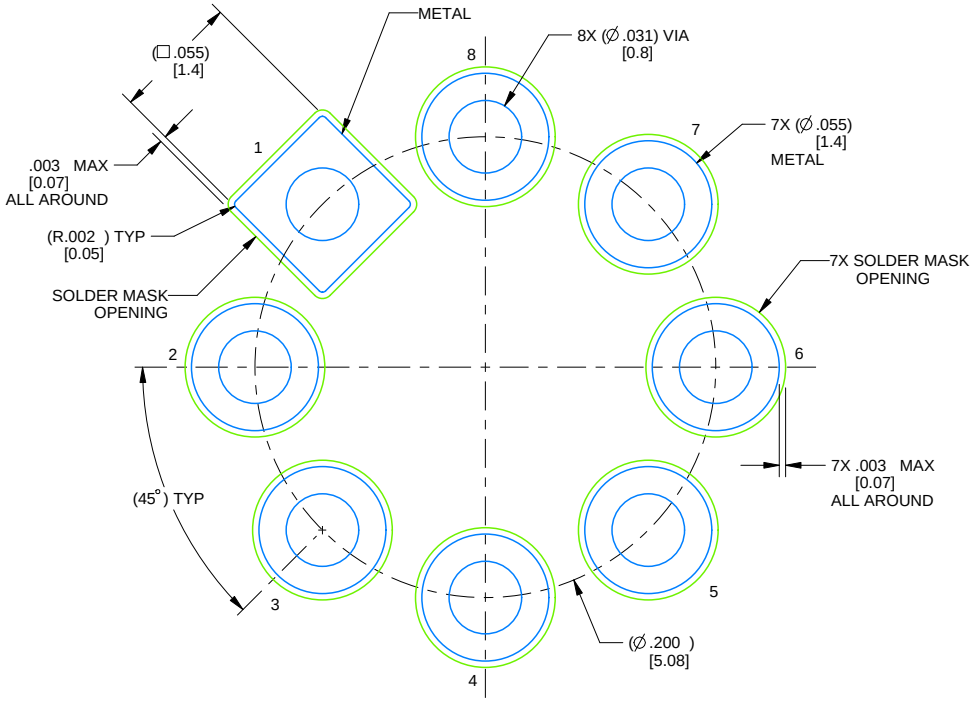
TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



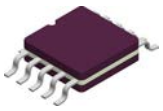
NOTES:

1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Pin numbers shown for reference only. Numbers may not be marked on package.
4. Reference JEDEC registration MO-002/TO-99.



LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 12X

4220610/B 09/2024

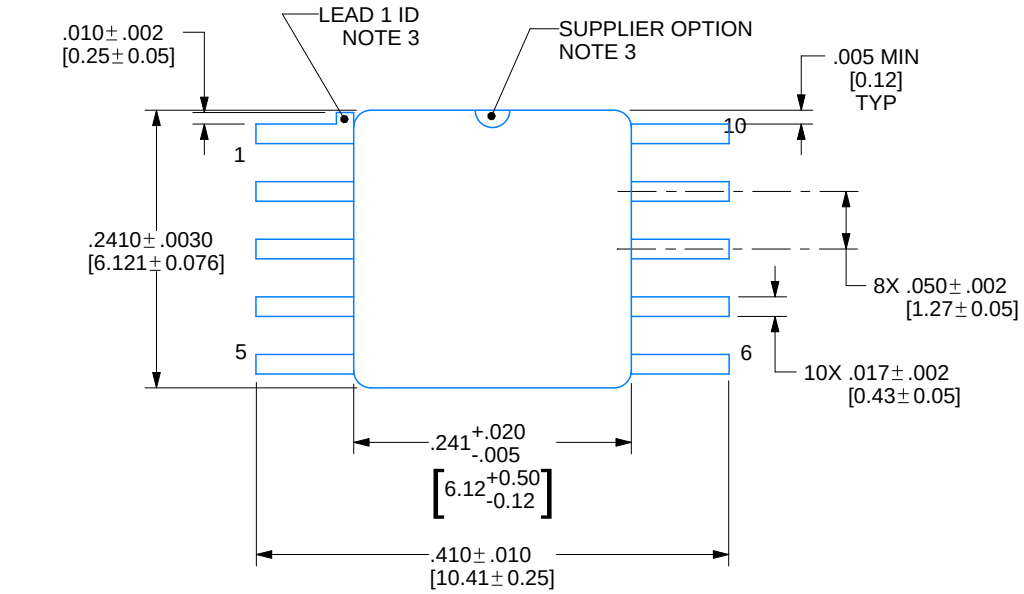


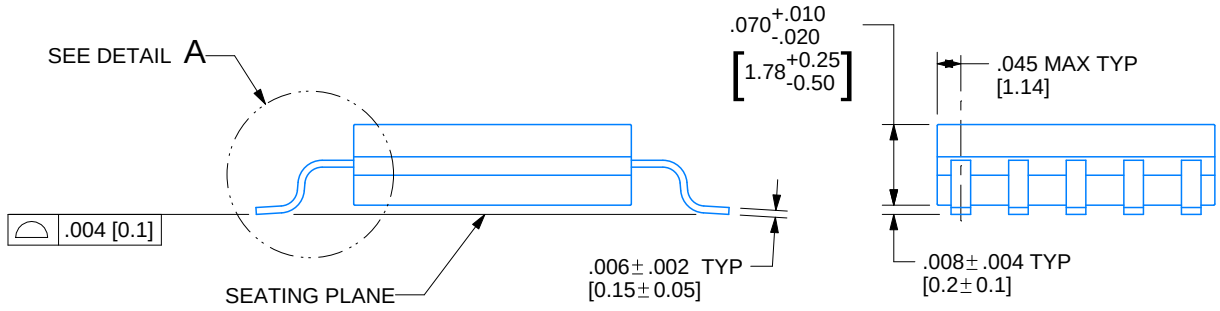
PACKAGE OUTLINE

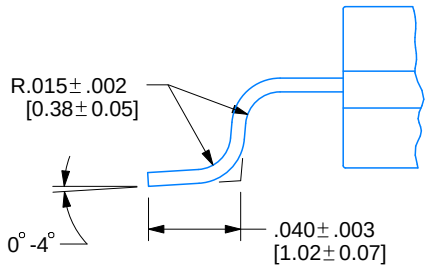
NAC0010A

CFP - 2.33mm max height

CERAMIC FLATPACK







DETAIL A
TYPICAL

4215196/D 08/2022

NOTES:

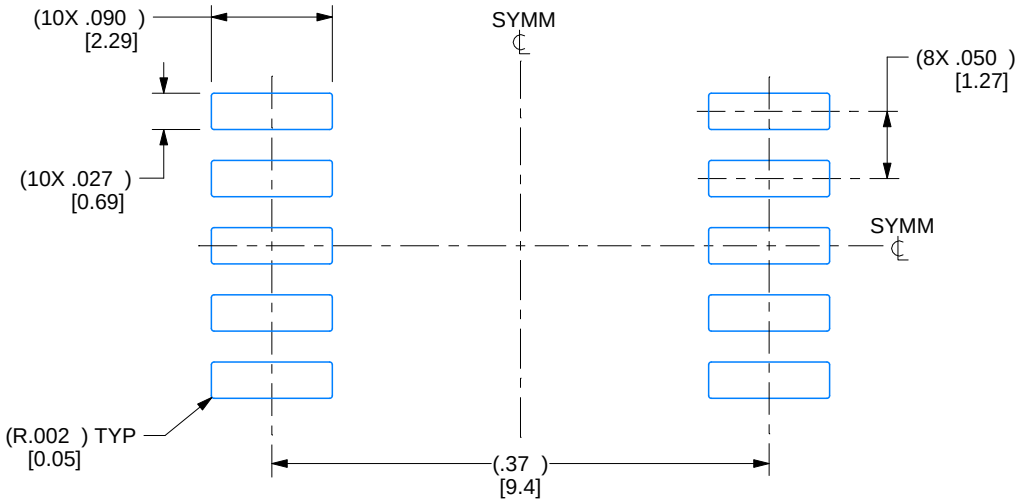
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. For solder thickness and composition, see the "Lead Finish Composition/Thickness" link in the packaging section of the Texas Instruments website
3. Lead 1 identification shall be:
   a) A notch or other mark within this area
   b) A tab on lead 1, either side
4. No JEDEC registration as of December 2021

EXAMPLE BOARD LAYOUT

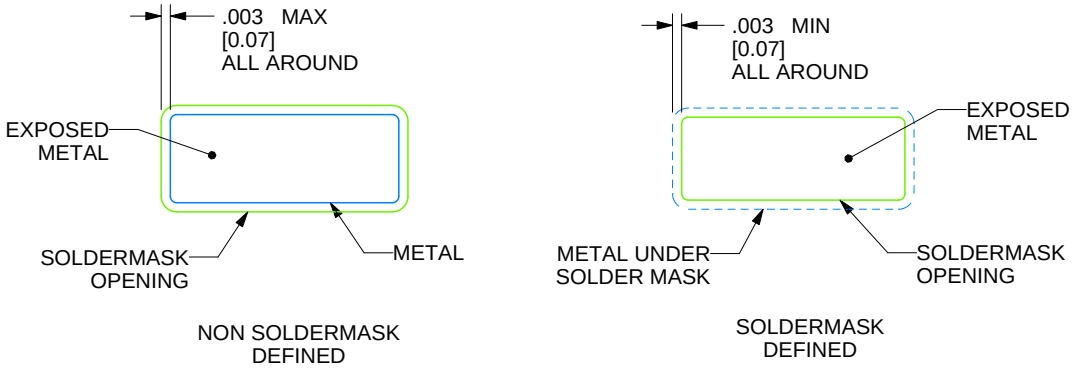
NAC0010A

CFP - 2.33mm max height

CERAMIC FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 7X



4215196/D 08/2022

REVISIONS

REV	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	2197877	12/30/2021	DAVID CHIN / ANIS FAUZI
B	NO CHANGE TO DRAWING; REVISION FOR YODA RELEASE;	2198820	02/14/2022	K. SINCERBOX
C	CHANGE PIN 1 ID LOCATION ON PIN	2198845	02/18/2022	D. CHIN / K. SINCERBOX
D	.2410± .0030 WAS .2700 +.0012/-.0002;	2200915	08/08/2022	D. CHIN / K. SINCERBOX

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